



# Product Change Notification

**Change Notification #:** 114472 - 00

**Change Title:** Intel® Server System R1304JP4GS and Intel® Server System R1208JP4OC, PCN 114472-00, Label, Update Regulatory and Safety Labels

**Date of Publication:** March 18, 2016

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	April 4, 2016
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*\*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems R1304JP4GS and Intel® Server System R1208JP4OC:

1. Update the packaging regulatory label, with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo.

Please see Figure-1 and Figure-2 below for details.



Figure-1: Pre-Change



Figure-2: Post-change

2. Update the regulatory label with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-3 and Figure-4 below for details.



Figure-3: Pre-Change



Figure-4: Post-Change

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
R1208JP4OC	923166	G79357-004	G79357-005
R1304JP4GS	923168	G79360-003	G79360-004

**PCN Revision History:****Date of Revision:**

March 18, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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## #114472 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

Americas Contact: [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

Asia Pacific/PRC Contact: [apacgccb@intel.com](mailto:apacgccb@intel.com)

Europe Email: [eccb@intel.com](mailto:eccb@intel.com)

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